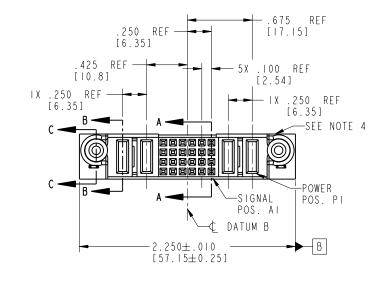
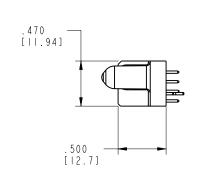
1|2 POWER SIGNAL POWER ROW S PRODUCT NO. E2 Р3 P2 E1 D C B A 51750-047\_\_ NOTE: 3





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CODE	MA	"M" FING NGTH	CONTACT TYPE
Ε	N/A	[N/A]	SIGNAL
PΑ	.042	[1.07]	POWER
PD	.092	[2.34]	POWER
НΑ	N/A	[N/A]	HOLD-DOWN

mat'l code			SEE	NOT	E 2	tolerances unless otherwise specified					CUSTOMER				D	<b>k</b>							
ltr	ecn	no.	dr	do	ate	.XX±.01/0.X±				).3	1	COPY		FCI www.fcicor							nnect.com		
A	V03-	0483	TAB	04/3	0/03	linear	. X X X	.XXX±.005/0.XX±0.13			projec	tion		title		2P -	+ 24	4S +	+ 2F	)			
В	DG05	-0504	GuoJM	11/2	9/05		.XXXX±.0020/0.XXX±0.051							\/ E		LI LIO							
						angles		0°±2°			7		7	V C	. П. І	CAL	30	LVE	ER RECEPT				
						dr	T. BR	BRUNGARD 04/30/03		INCH/MM			produc	t fami	ily	ade							
						engr			4/30/03	scale			size	e dwg no					21				
						chr			04/30/03				Λ	5	171	5Λ-	- /	sheet					
			appd M. MOSTOLLER 04/30/03		1:1			А	J	51/50-0				l of 4									
she	sheet 16		sion	В	В	В	В																
inc	iex	she	et	- 1	2	3	4																
				Pr	o/E							3			co	ge cod	e 2	252	26		4		

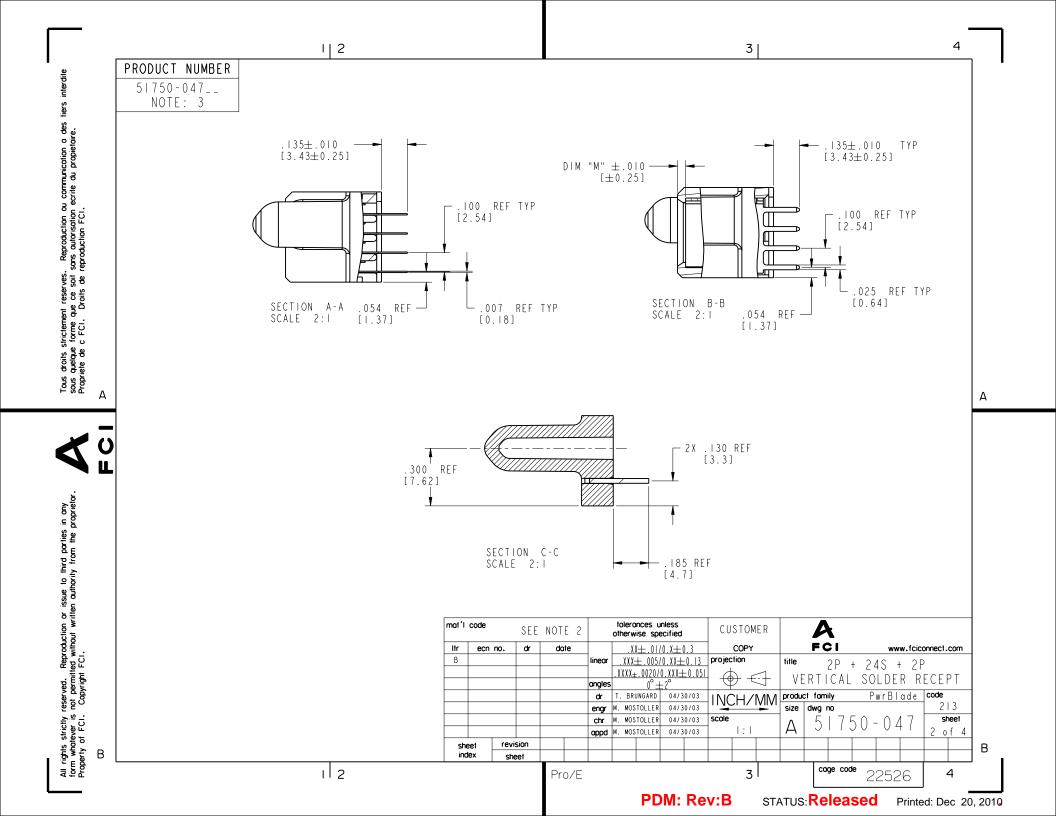
PDM: Rev:B

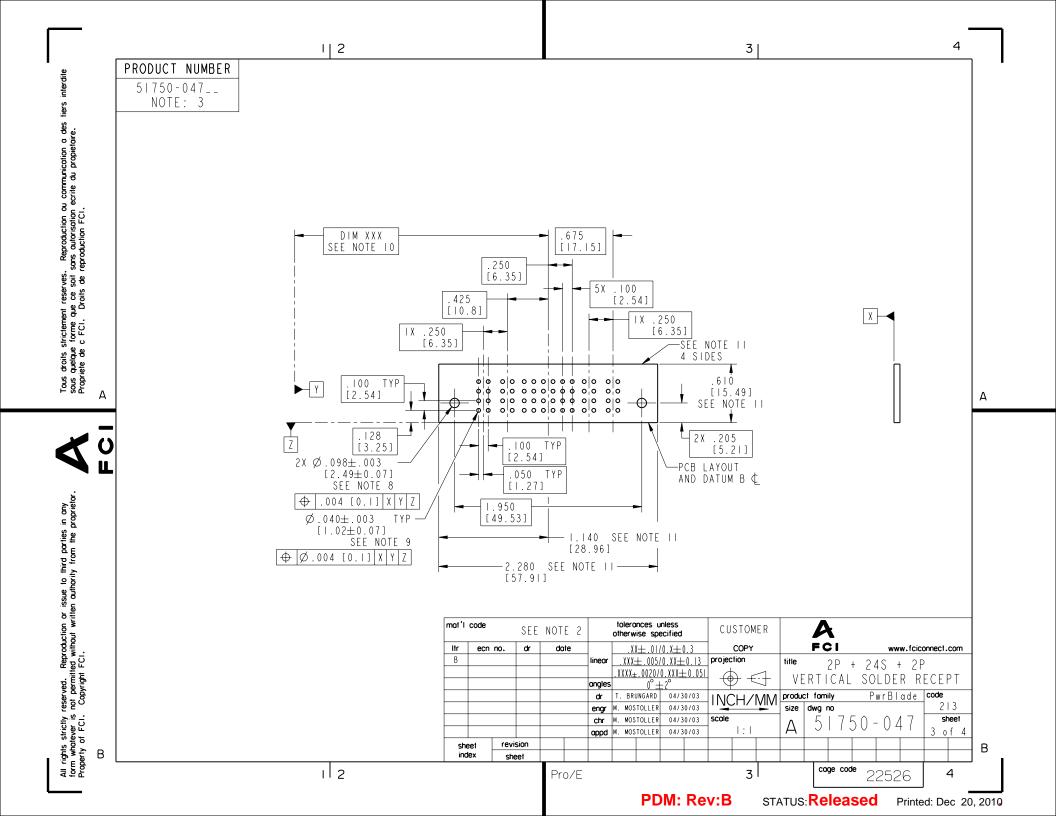
STATUS: Released Printed: Dec 20, 2010

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PRODUCT NUMBER

51750-047\_\_ NOTE: 3

NOTES:

I. DIMENSIONS AND TOLERANCES ARE IN ACCORDANCE WITH ASME YI4.5M, 1994 UNLESS OTHERWISE SPECIFIED.

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CONNECTOR NOTES:

HOUSING MATERIAL: UL 94 V-0 GLASS FILLED

HIGH-TEMP THERMOPLASTIC

POWER CONTACT MATERIAL: COPPER ALLOY SIGNAL PIN MATERIAL: COPPER ALLOY

3. PLATING:

Singal Pin:30u"/0.76um Au OVER 50u"/1.27um Ni ON THE CONTACT AREA. 51750-047

AND 100u"/2.54um SnPb PLATING OVER 50u"/1.27um Ni ON THE TERMINATION SECTION. Power Pin: 30u"/0.76um Au OVER 50u"/1.27um Ni ON THE CONTACT AREA.

AND 100u"/2.54um SnPb PLATING OVER 50u"/1.27um Ni ON THE TERMINATION SECTION.

51750-047LF Singal Pin:30u"/0.76um Au OVER 50u"/1.27um Ni ON THE CONTACT AREA.

AND 78u"/2.00um Sn PLATING OVER 50u"/1.27um Ni ON THE TERMINATION SECTION.

Power Pin: 30u"/0.76um Au OVER 50u"/1.27um Ni ON THE CONTACT AREA,

AND 78u"/2.00um Sn PLATING OVER 50u"/I.27um Ni ON THE TERMINATION SECTION.

PART NUMBER 51750-047LF MEETS EUROPEAN UNION DIRECTIVE AND OTHER JCOUNTRY REGULATIONS AS DESCRIBED IN GS-22-008.

THE HOUSING WILL WITHSTAND EXPOSURE TO 260° PEAK TEMPERATURE FOR 10 SECONDS IN A WAVE SOLDER APPLICATION WITH A CIRCUIT BOARD.

MANUFACTURER'S NAME, P/N, AND DATE CODE TO APPEAR ON THIS SURFACE.

5. PRODUCT SPECIFICATION GS-12-149. APPLICATION SPECIFICATION BUS-20-067.

6. PACKAGED IN TRAYS.

PCB NOTES:

7. ALL HOLE DIAMETERS ARE FINISHED HOLE SIZE.

MOUNTING HOLES, WHERE APPLICABLE, ARE UNPLATED.

 $\emptyset$ .0453 $\pm$ .0010 [I.151 $\pm$ 0.025] DRILLED HOLES PLATED WITH

.0003 [0.008] MIN SnPb OVER .001 [0.03] TO .003 [0.08] Cu PLATING TO ACHIEVE Ø.040±.003 [1.02±.07] HOLE.

"DIM XXX" TO BE DETERMINED BY THE CUSTOMER. 10

CONNECTOR KEEP-OUT ZONE.

mat'l code			SEE NOTE 2			tolerances unless otherwise specified					CU	CUSTOMER				k						
ltr	ecn	no.	dr date				.XX±.01/0.X±0.3			1	COPY			FC	<b>)</b>		ww	w.fcic	onnect.	.com		
В					linear	.XXX±.005/0.XX±0.13				projection		title		2 P	+ 2	P						
						angles	.XXXX±.0020/0.XXX±0.051 0°+2°							V E		CAL	_		DER R		PΤ	
						dr	T. BRUNGARD 04/30/0		30/03	INCH/MN			produc	uct family P			owrBlade -		code			
						engr		M. MOSTOLLER		04/30/03		TI VCI IZ IVIIVI		size	dwg	no				2	13	
						chr	M. MOSTOLLER		04/30/03		scale				5	17	50-	- 0 /	17	sheet		
						appd	M. MOS	TOLLER	04/3	80/03		1:1		А		1 / \	<i>J</i>	0 -	† /	4 0	f 4	
she	eet	revi	sion																			
inc	lex	× she																				
				Pro	o/E						3					coge code 22526					4	

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PDM: Rev:B

STATUS: Released

Printed: Dec 20, 2010

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